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Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Product Status	Obsolete
Core Processor	MPC8xx
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	50MHz
Co-Processors/DSP	Communications; CPM
RAM Controllers	DRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10Mbps (4), 10/100Mbps (1)
SATA	-
USB	-
Voltage - I/O	3.3V
Operating Temperature	0°C ~ 105°C (TA)
Security Features	-
Package / Case	357-BBGA
Supplier Device Package	357-PBGA (25x25)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mpc862pvr50b

1 Overview

The MPC862/857T/857DSL is a derivative of Freescale's MPC860 PowerQUICC™ family of devices. It is a versatile single-chip integrated microprocessor and peripheral combination that can be used in a variety of controller applications and communications and networking systems. The MPC862/857T/857DSL provides enhanced ATM functionality over that of other ATM-enabled members of the MPC860 family.

Table 1 shows the functionality supported by the members of the MPC862/857T/857DSL family.

Table 1. MPC862 Family Functionality

Part	Cache		Ethernet		SCC	SMC
	Instruction Cache	Data Cache	10T	10/100		
MPC862P	16 Kbyte	8 Kbyte	Up to 4	1	4	2
MPC862T	4 Kbyte	4 Kbyte	Up to 4	1	4	2
MPC857T	4 Kbyte	4 Kbyte	1	1	1	2
MPC857DSL	4 Kbyte	4 Kbyte	1	1	1 ¹	1 ²

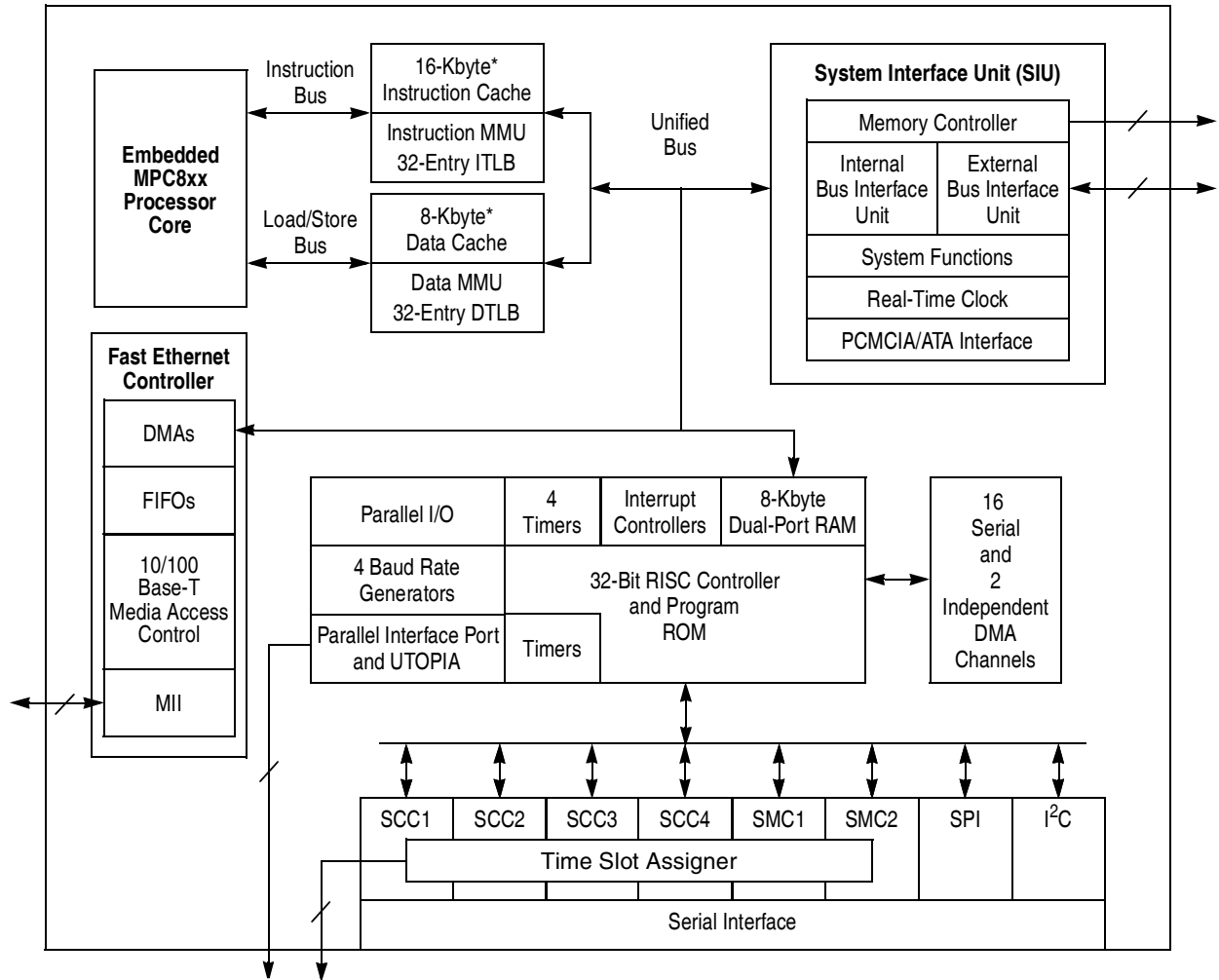
¹ On the MPC857DSL, the SCC (SCC1) is for ethernet only. Also, the MPC857DSL does not support the Time Slot Assigner (TSA).

² On the MPC857DSL, the SMC (SMC1) is for UART only.

2 Features

The following list summarizes the key MPC862/857T/857DSL features:

- Embedded single-issue, 32-bit MPC8xx core (implementing the PowerPC architecture) with thirty-two 32-bit general-purpose registers (GPRs)
 - The core performs branch prediction with conditional prefetch, without conditional execution
 - 4- or 8-Kbyte data cache and 4- or 16-Kbyte instruction cache (see Table 1).
 - 16-Kbyte instruction cache (MPC862P) is four-way, set-associative with 256 sets; 4-Kbyte instruction cache (MPC862T, MPC857T, and MPC857DSL) is two-way, set-associative with 128 sets.
 - 8-Kbyte data cache (MPC862P) is two-way, set-associative with 256 sets; 4-Kbyte data cache (MPC862T, MPC857T, and MPC857DSL) is two-way, set-associative with 128 sets.
 - Cache coherency for both instruction and data caches is maintained on 128-bit (4-word) cache blocks.
 - Caches are physically addressed, implement a least recently used (LRU) replacement algorithm, and are lockable on a cache block basis.
 - MMUs with 32-entry TLB, fully associative instruction and data TLBs
 - MMUs support multiple page sizes of 4, 16, and 512 Kbytes, and 8 Mbytes; 16 virtual address spaces and 16 protection groups
 - Advanced on-chip-emulation debug mode



*The MPC862T contains 4-Kbyte instruction cache and 4-Kbyte data cache.

Figure 1. MPC862P/862T Block Diagram

Table 7 provides the bus operation timing for the MPC862/857T/857DSL at 33 MHz, 40 Mhz, 50 MHz and 66 Mhz.

The timing for the MPC862/857T/857DSL bus shown assumes a 50-pF load for maximum delays and a 0-pF load for minimum delays.

Table 7. Bus Operation Timings

Num	Characteristic	33 MHz		40 MHz		50 MHz		66 MHz		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
B1	CLKOUT period	30.30	30.30	25.00	30.30	20.00	30.30	15.15	30.30	ns
B1a	EXTCLK to CLKOUT phase skew (EXTCLK > 15 MHz and MF <= 2)	-0.90	0.90	-0.90	0.90	-0.90	0.90	-0.90	0.90	ns
B1b	EXTCLK to CLKOUT phase skew (EXTCLK > 10 MHz and MF < 10)	-2.30	2.30	-2.30	2.30	-2.30	2.30	-2.30	2.30	ns
B1c	CLKOUT phase jitter (EXTCLK > 15 MHz and MF <= 2) ¹	-0.60	0.60	-0.60	0.60	-0.60	0.60	-0.60	0.60	ns
B1d	CLKOUT phase jitter ¹	-2.00	2.00	-2.00	2.00	-2.00	2.00	-2.00	2.00	ns
B1e	CLKOUT frequency jitter (MF < 10) ¹	—	0.50	—	0.50	—	0.50	—	0.50	%
B1f	CLKOUT frequency jitter (10 < MF < 500) ¹	—	2.00	—	2.00	—	2.00	—	2.00	%
B1g	CLKOUT frequency jitter (MF > 500) ¹	—	3.00	—	3.00	—	3.00	—	3.00	%
B1h	Frequency jitter on EXTCLK ²	—	0.50	—	0.50	—	0.50	—	0.50	%
B2	CLKOUT pulse width low (MIN = 0.040 x B1)	12.10	—	10.00	—	8.00	—	6.10	—	ns
B3	CLKOUT width high (MIN = 0.040 x B1)	12.10	—	10.00	—	8.00	—	6.10	—	ns
B4	CLKOUT rise time ³ (MAX = 0.00 x B1 + 4.00)	—	4.00	—	4.00	—	4.00	—	4.00	ns
B5 ³³	CLKOUT fall time ³ (MAX = 0.00 x B1 + 4.00)	—	4.00	—	4.00	—	4.00	—	4.00	ns
B7	CLKOUT to A(0:31), BADDR(28:30), RD/WR, BURST, D(0:31), DP(0:3) invalid (MIN = 0.25 x B1)	7.60	—	6.30	—	5.00	—	3.80	—	ns
B7a	CLKOUT to TSIZ(0:1), REG, RSV, AT(0:3), BDIP, PTR invalid (MIN = 0.25 x B1)	7.60	—	6.30	—	5.00	—	3.80	—	ns
B7b	CLKOUT to BR, BG, FRZ, VFLS(0:1), VF(0:2) IWP(0:2), LWP(0:1), STS invalid ⁴ (MIN = 0.25 x B1)	7.60	—	6.30	—	5.00	—	3.80	—	ns
B8	CLKOUT to A(0:31), BADDR(28:30) RD/WR, BURST, D(0:31), DP(0:3) valid (MAX = 0.25 x B1 + 6.3)	7.60	13.80	6.30	12.50	5.00	11.30	3.80	10.00	ns

Table 7. Bus Operation Timings (continued)

Num	Characteristic	33 MHz		40 MHz		50 MHz		66 MHz		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
B17a	CLKOUT to $\overline{KR}$, $\overline{RETRY}$, $\overline{CR}$ valid (hold time) (MIN = 0.00 x B1 + 2.00)	2.00	—	2.00	—	2.00	—	2.00	—	ns
B18	D(0:31), DP(0:3) valid to CLKOUT rising edge (setup time) ⁸ (MIN = 0.00 x B1 + 6.00)	6.00	—	6.00	—	6.00	—	6.00	—	ns
B19	CLKOUT rising edge to D(0:31), DP(0:3) valid (hold time) ⁸ (MIN = 0.00 x B1 + 1.00 ⁹)	1.00	—	1.00	—	1.00	—	2.00	—	ns
B20	D(0:31), DP(0:3) valid to CLKOUT falling edge (setup time) ¹⁰ (MIN = 0.00 x B1 + 4.00)	4.00	—	4.00	—	4.00	—	4.00	—	ns
B21	CLKOUT falling edge to D(0:31), DP(0:3) valid (hold Time) ¹⁰ (MIN = 0.00 x B1 + 2.00)	2.00	—	2.00	—	2.00	—	2.00	—	ns
B22	CLKOUT rising edge to $\overline{CS}$ asserted GPCM ACS = 00 (MAX = 0.25 x B1 + 6.3)	7.60	13.80	6.30	12.50	5.00	11.30	3.80	10.00	ns
B22a	CLKOUT falling edge to $\overline{CS}$ asserted GPCM ACS = 10, TRLX = 0 (MAX = 0.00 x B1 + 8.00)	—	8.00	—	8.00	—	8.00	—	8.00	ns
B22b	CLKOUT falling edge to $\overline{CS}$ asserted GPCM ACS = 11, TRLX = 0, EBDF = 0 (MAX = 0.25 x B1 + 6.3)	7.60	13.80	6.30	12.50	5.00	11.30	3.80	10.00	ns
B22c	CLKOUT falling edge to $\overline{CS}$ asserted GPCM ACS = 11, TRLX = 0, EBDF = 1 (MAX = 0.375 x B1 + 6.6)	10.90	18.00	10.90	18.00	7.00	14.30	5.20	12.30	ns
B23	CLKOUT rising edge to $\overline{CS}$ negated GPCM read access, GPCM write access ACS = 00, TRLX = 0 & CSNT = 0 (MAX = 0.00 x B1 + 8.00)	2.00	8.00	2.00	8.00	2.00	8.00	2.00	8.00	ns
B24	A(0:31) and BADDR(28:30) to $\overline{CS}$ asserted GPCM ACS = 10, TRLX = 0 (MIN = 0.25 x B1 - 2.00)	5.60	—	4.30	—	3.00	—	1.80	—	ns
B24a	A(0:31) and BADDR(28:30) to $\overline{CS}$ asserted GPCM ACS = 11 TRLX = 0 (MIN = 0.50 x B1 - 2.00)	13.20	—	10.50	—	8.00	—	5.60	—	ns
B25	CLKOUT rising edge to $\overline{OE}$, $\overline{WE}$ (0:3) asserted (MAX = 0.00 x B1 + 9.00)	—	9.00		9.00		9.00		9.00	ns
B26	CLKOUT rising edge to $\overline{OE}$ negated (MAX = 0.00 x B1 + 9.00)	2.00	9.00	2.00	9.00	2.00	9.00	2.00	9.00	ns

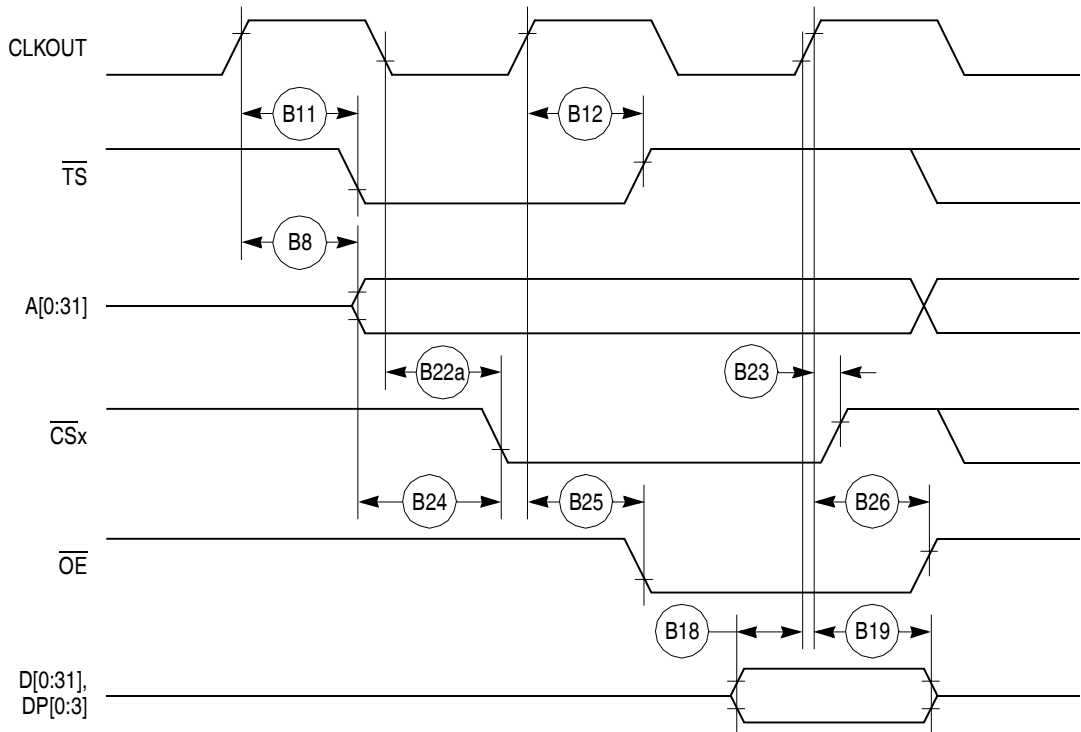


Figure 12. External Bus Read Timing (GPCM Controlled—TRLX = 0, ACS = 10)

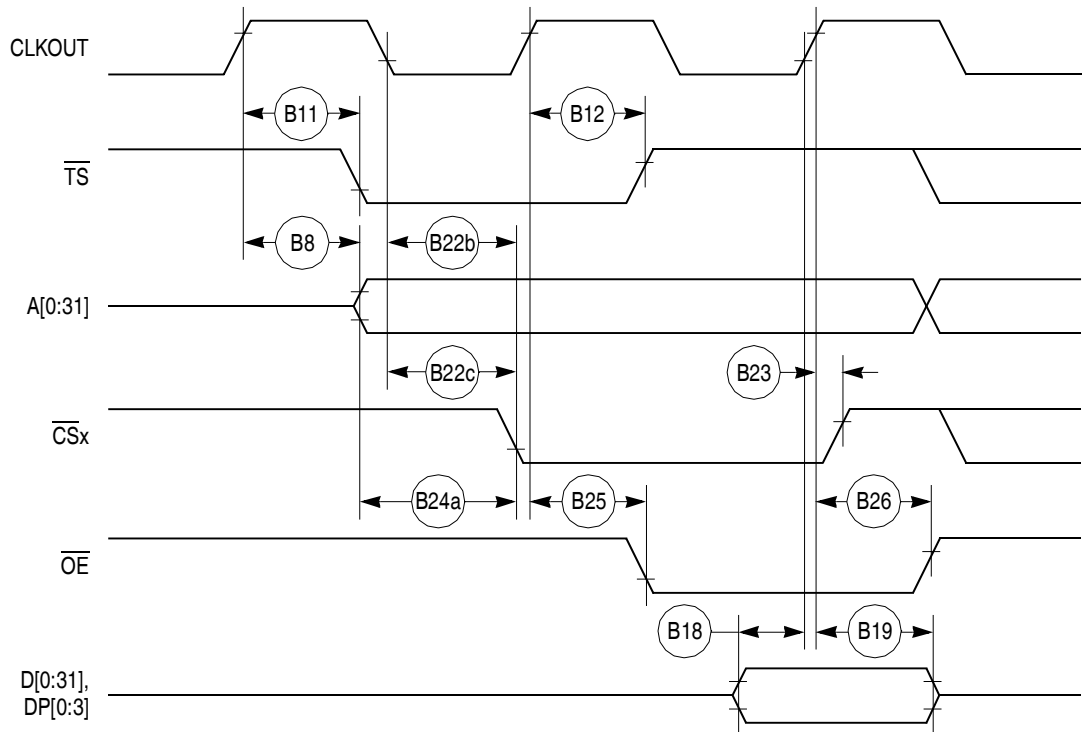


Figure 13. External Bus Read Timing (GPCM Controlled—TRLX = 0, ACS = 11)

Table 9 shows the PCMCIA timing for the MPC862/857T/857DSL.

Table 9. PCMCIA Timing

Num	Characteristic	33 MHz		40 MHz		50 MHz		66 MHz		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
P44	A(0:31), $\overline{\text{REG}}$ valid to PCMCIA Strobe asserted. ¹ (MIN = 0.75 x B1 - 2.00)	20.70	—	16.70	—	13.00	—	9.40	—	ns
P45	A(0:31), $\overline{\text{REG}}$ valid to ALE negation. ¹ (MIN = 1.00 x B1 - 2.00)	28.30	—	23.00	—	18.00	—	13.20	—	ns
P46	CLKOUT to $\overline{\text{REG}}$ valid (MAX = 0.25 x B1 + 8.00)	7.60	15.60	6.30	14.30	5.00	13.00	3.80	11.80	ns
P47	CLKOUT to $\overline{\text{REG}}$ Invalid. (MIN = 0.25 x B1 + 1.00)	8.60	—	7.30	—	6.00	—	4.80	—	ns
P48	CLKOUT to $\overline{\text{CE1}}$, $\overline{\text{CE2}}$ asserted. (MAX = 0.25 x B1 + 8.00)	7.60	15.60	6.30	14.30	5.00	13.00	3.80	11.80	ns
P49	CLKOUT to $\overline{\text{CE1}}$, $\overline{\text{CE2}}$ negated. (MAX = 0.25 x B1 + 8.00)	7.60	15.60	6.30	14.30	5.00	13.00	3.80	11.80	ns
P50	CLKOUT to $\overline{\text{PCOE}}$, $\overline{\text{IORD}}$, $\overline{\text{PCWE}}$, $\overline{\text{IOWR}}$ assert time. (MAX = 0.00 x B1 + 11.00)	—	11.00	—	11.00	—	11.00	—	11.00	ns
P51	CLKOUT to $\overline{\text{PCOE}}$, $\overline{\text{IORD}}$, $\overline{\text{PCWE}}$, $\overline{\text{IOWR}}$ negate time. (MAX = 0.00 x B1 + 11.00)	2.00	11.00	2.00	11.00	2.00	11.00	2.00	11.00	ns
P52	CLKOUT to ALE assert time (MAX = 0.25 x B1 + 6.30)	7.60	13.80	6.30	12.50	5.00	11.30	3.80	10.00	ns
P53	CLKOUT to ALE negate time (MAX = 0.25 x B1 + 8.00)	—	15.60	—	14.30	—	13.00	—	11.80	ns
P54	$\overline{\text{PCWE}}$, $\overline{\text{IOWR}}$ negated to D(0:31) invalid. ¹ (MIN = 0.25 x B1 - 2.00)	5.60	—	4.30	—	3.00	—	1.80	—	ns
P55	$\overline{\text{WAITA}}$ and $\overline{\text{WAITB}}$ valid to CLKOUT rising edge. ¹ (MIN = 0.00 x B1 + 8.00)	8.00	—	8.00	—	8.00	—	8.00	—	ns
P56	CLKOUT rising edge to $\overline{\text{WAITA}}$ and $\overline{\text{WAITB}}$ invalid. ¹ (MIN = 0.00 x B1 + 2.00)	2.00	—	2.00	—	2.00	—	2.00	—	ns

¹ PSST = 1. Otherwise add PSST times cycle time.
PSHT = 0. Otherwise add PSHT times cycle time.

These synchronous timings define when the $\overline{\text{WAITx}}$ signals are detected in order to freeze (or relieve) the PCMCIA current cycle. The $\overline{\text{WAITx}}$ assertion will be effective only if it is detected 2 cycles before the PSL timer expiration. See PCMCIA Interface in the *MPC862 PowerQUICC User's Manual*.

Figure 27 provides the PCMCIA access cycle timing for the external bus write.

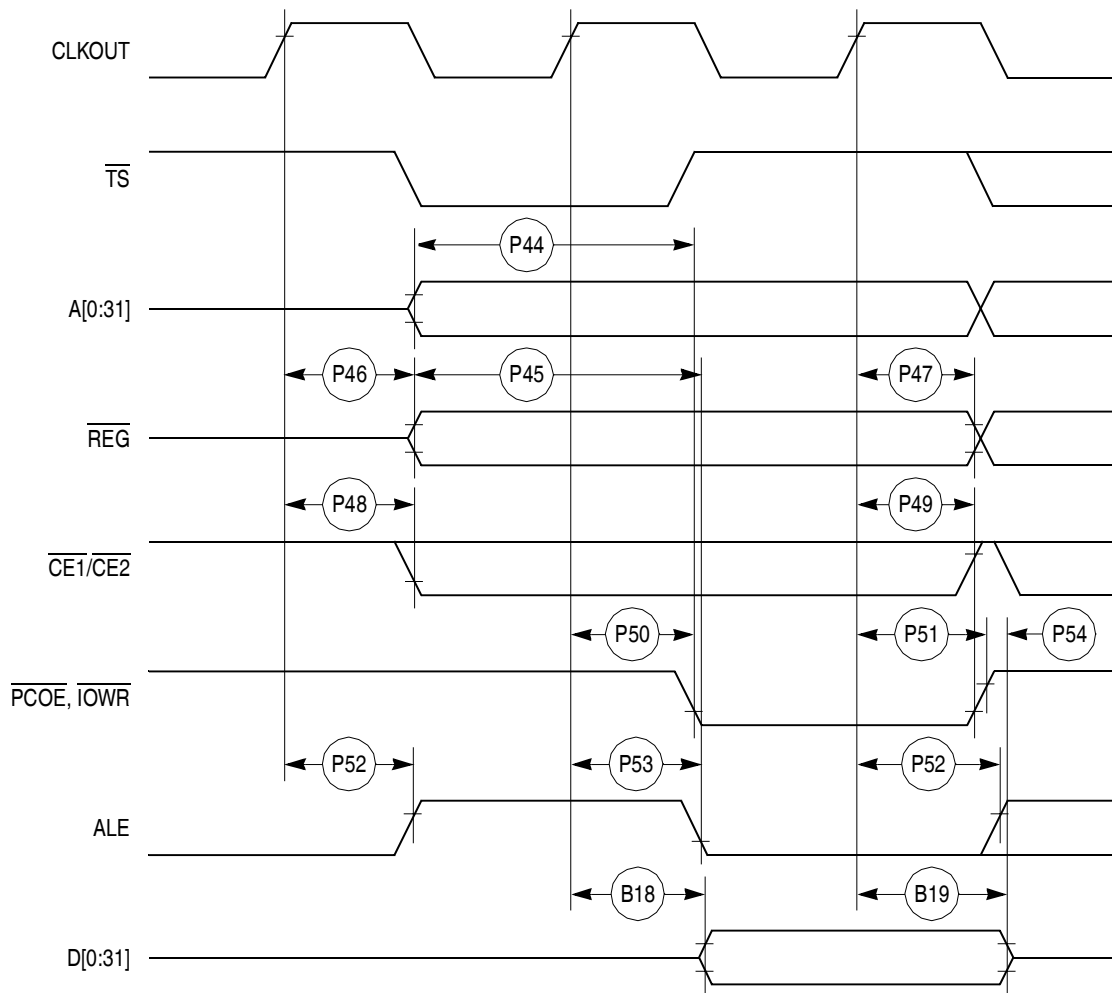


Figure 27. PCMCIA Access Cycles Timing External Bus Write

Figure 28 provides the PCMCIA $\overline{\text{WAIT}}$ signals detection timing.

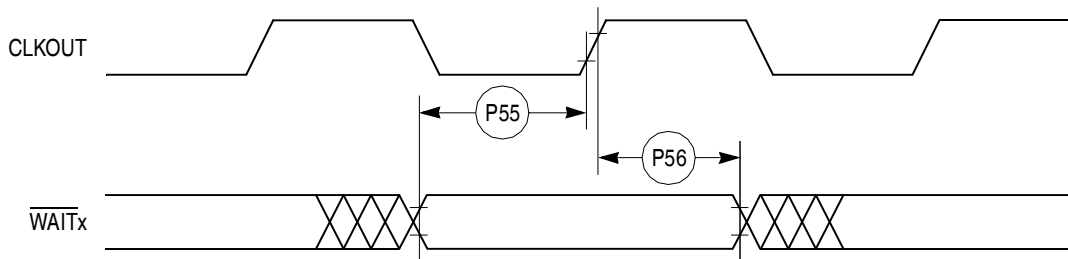


Figure 28. PCMCIA $\overline{\text{WAIT}}$ Signals Detection Timing

Table 10 shows the PCMCIA port timing for the MPC862/857T/857DSL.

Table 10. PCMCIA Port Timing

Num	Characteristic	33 MHz		40 MHz		50 MHz		66 MHz		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
P57	CLKOUT to OPx Valid (MAX = $0.00 \times B1 + 19.00$)	—	19.00	—	19.00	—	19.00	—	19.00	ns
P58	$\overline{\text{HRESET}}$ negated to OPx drive ¹ (MIN = $0.75 \times B1 + 3.00$)	25.70	—	21.70	—	18.00	—	14.40	—	ns
P59	IP_Xx valid to CLKOUT rising edge (MIN = $0.00 \times B1 + 5.00$)	5.00	—	5.00	—	5.00	—	5.00	—	ns
P60	CLKOUT rising edge to IP_Xx invalid (MIN = $0.00 \times B1 + 1.00$)	1.00	—	1.00	—	1.00	—	1.00	—	ns

¹ OP2 and OP3 only.

Figure 29 provides the PCMCIA output port timing for the MPC862/857T/857DSL.

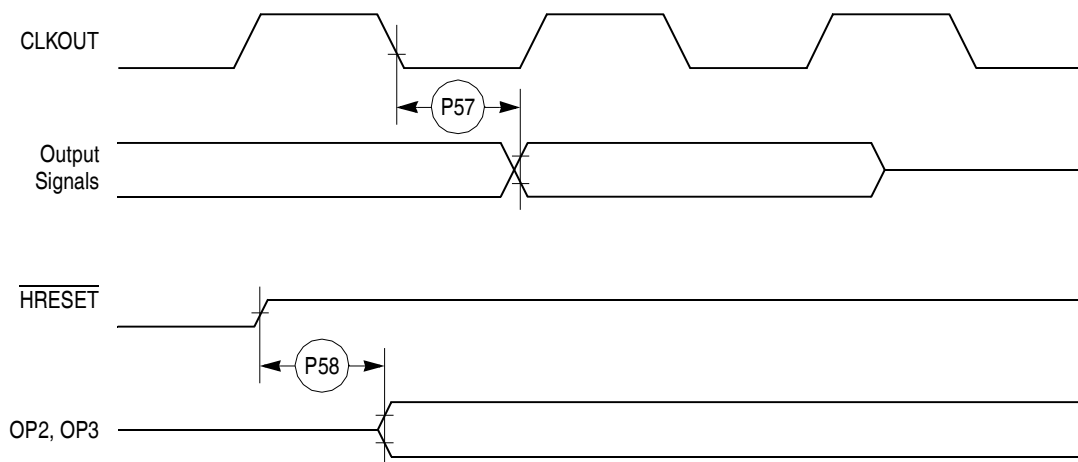


Figure 29. PCMCIA Output Port Timing

Figure 30 provides the PCMCIA output port timing for the MPC862/857T/857DSL.

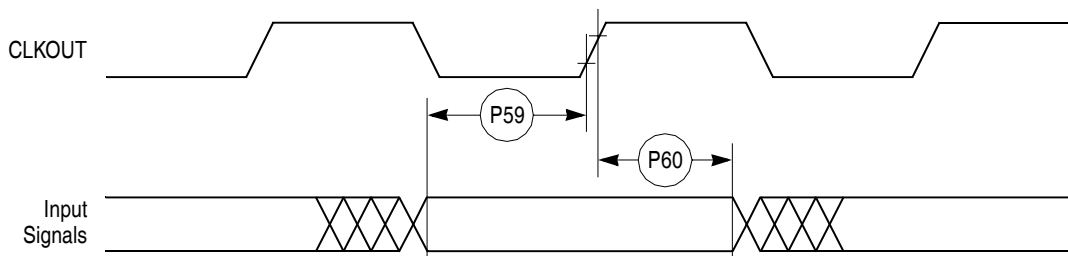


Figure 30. PCMCIA Input Port Timing

Figure 33 shows the reset timing for the data bus configuration.

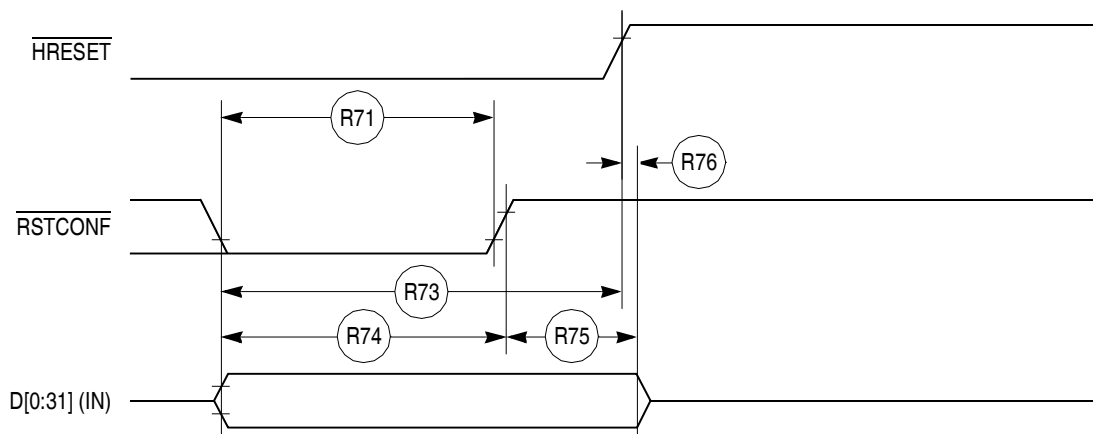


Figure 33. Reset Timing—Configuration from Data Bus

Figure 34 provides the reset timing for the data bus weak drive during configuration.

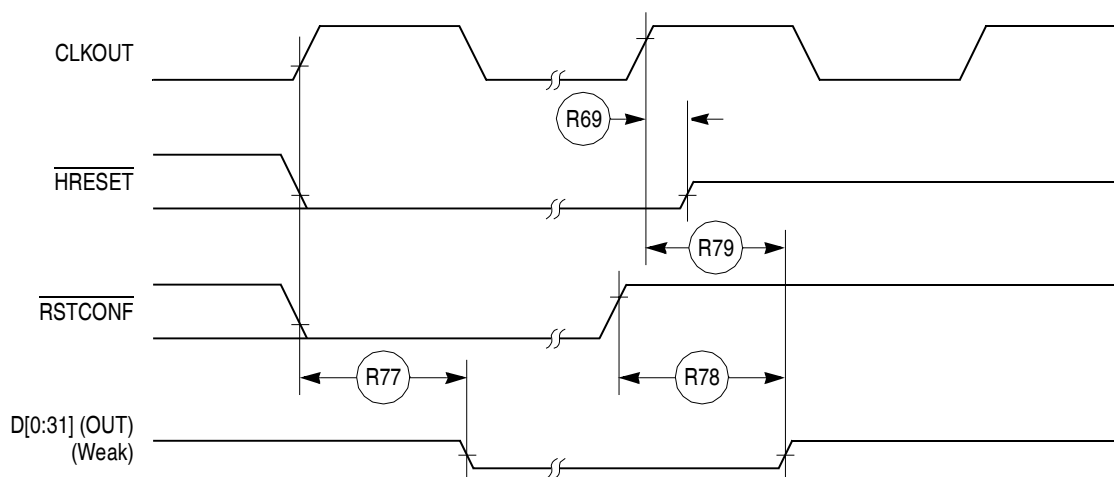


Figure 34. Reset Timing—Data Bus Weak Drive during Configuration

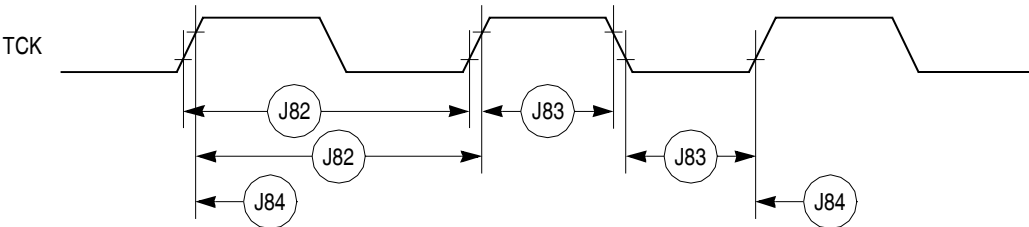


Figure 36. JTAG Test Clock Input Timing

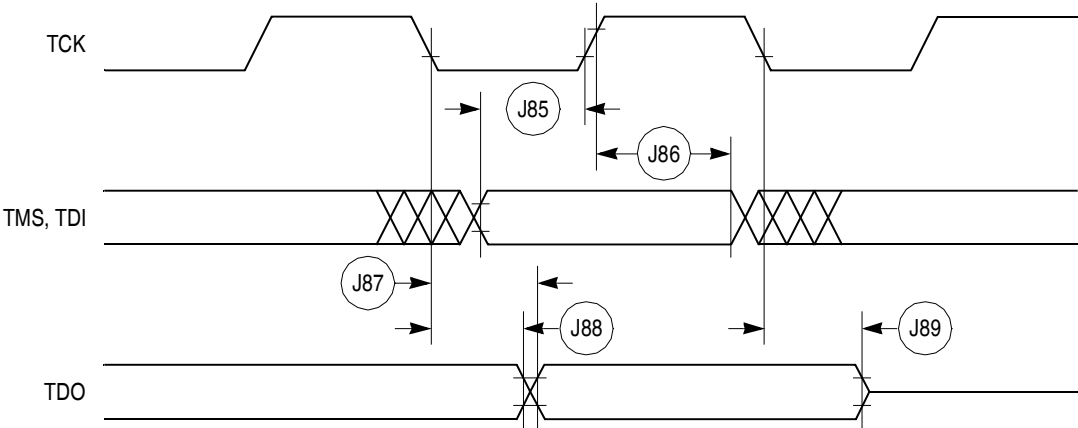


Figure 37. JTAG Test Access Port Timing Diagram

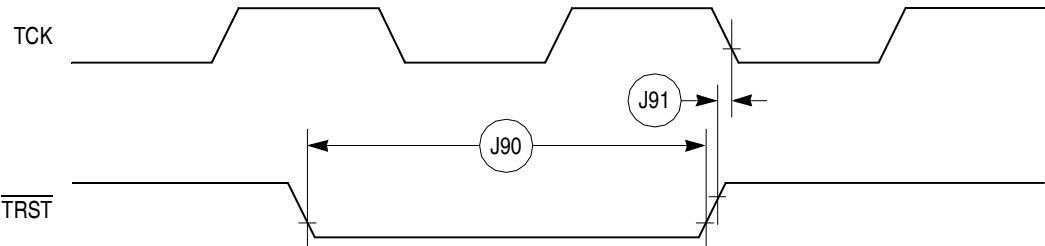


Figure 38. JTAG $\overline{\text{TRST}}$ Timing Diagram

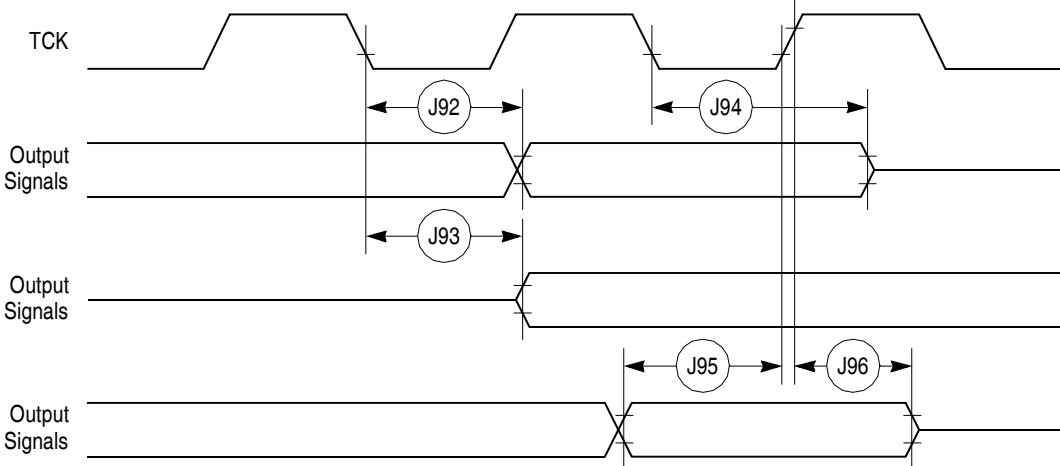


Figure 39. Boundary Scan (JTAG) Timing Diagram

11 CPM Electrical Characteristics

This section provides the AC and DC electrical specifications for the communications processor module (CPM) of the MPC862/857T/857DSL.

11.1 PIP/PIO AC Electrical Specifications

Table 14 provides the PIP/PIO AC timings as shown in Figure 40 though Figure 44.

Table 14. PIP/PIO Timing

Num	Characteristic	All Frequencies		Unit
		Min	Max	
21	Data-in setup time to STBI low	0	—	ns
22	Data-in hold time to STBI high	$2.5 - t_3^1$	—	clk
23	STBI pulse width	1.5	—	clk
24	STBO pulse width	1 clk – 5 ns	—	ns
25	Data-out setup time to STBO low	2	—	clk
26	Data-out hold time from STBO high	5	—	clk
27	STBI low to STBO low (Rx interlock)	—	2	clk
28	STBI low to STBO high (Tx interlock)	2	—	clk
29	Data-in setup time to clock high	15	—	ns
30	Data-in hold time from clock high	7.5	—	ns
31	Clock low to data-out valid (CPU writes data, control, or direction)	—	25	ns

¹ t_3 = Specification 23

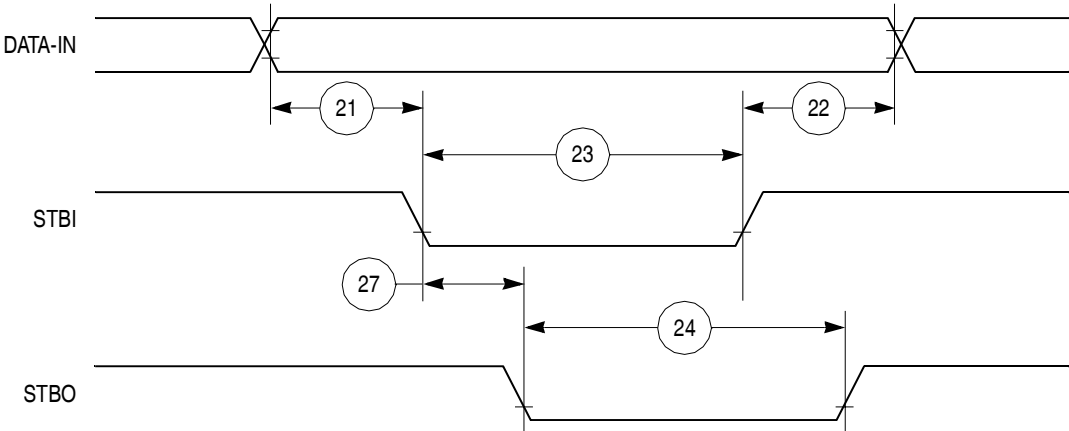


Figure 40. PIP Rx (Interlock Mode) Timing Diagram

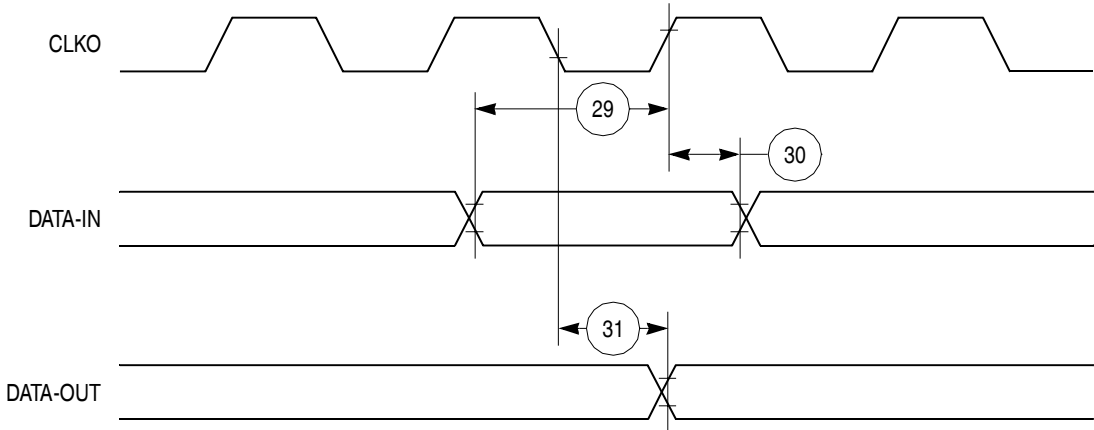


Figure 44. Parallel I/O Data-In/Data-Out Timing Diagram

11.2 Port C Interrupt AC Electrical Specifications

Table 15 provides the timings for port C interrupts.

Table 15. Port C Interrupt Timing

Num	Characteristic	33.34 MHz		Unit
		Min	Max	
35	Port C interrupt pulse width low (edge-triggered mode)	55	—	ns
36	Port C interrupt minimum time between active edges	55	—	ns

Figure 45 shows the port C interrupt detection timing.

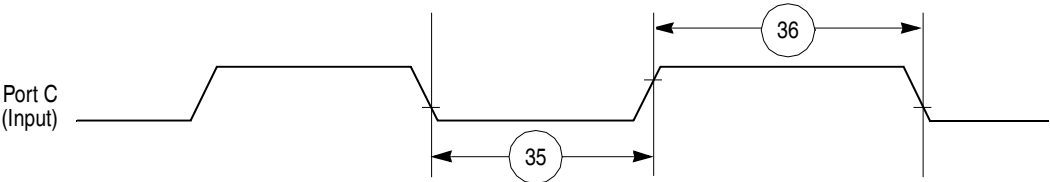


Figure 45. Port C Interrupt Detection Timing

11.3 IDMA Controller AC Electrical Specifications

Table 16 provides the IDMA controller timings as shown in Figure 46 though Figure 49.

Table 16. IDMA Controller Timing

Num	Characteristic	All Frequencies		Unit
		Min	Max	
40	$\overline{DREQ}$ setup time to clock high	7	—	ns
41	$\overline{DREQ}$ hold time from clock high	3	—	ns
42	$\overline{SDACK}$ assertion delay from clock high	—	12	ns

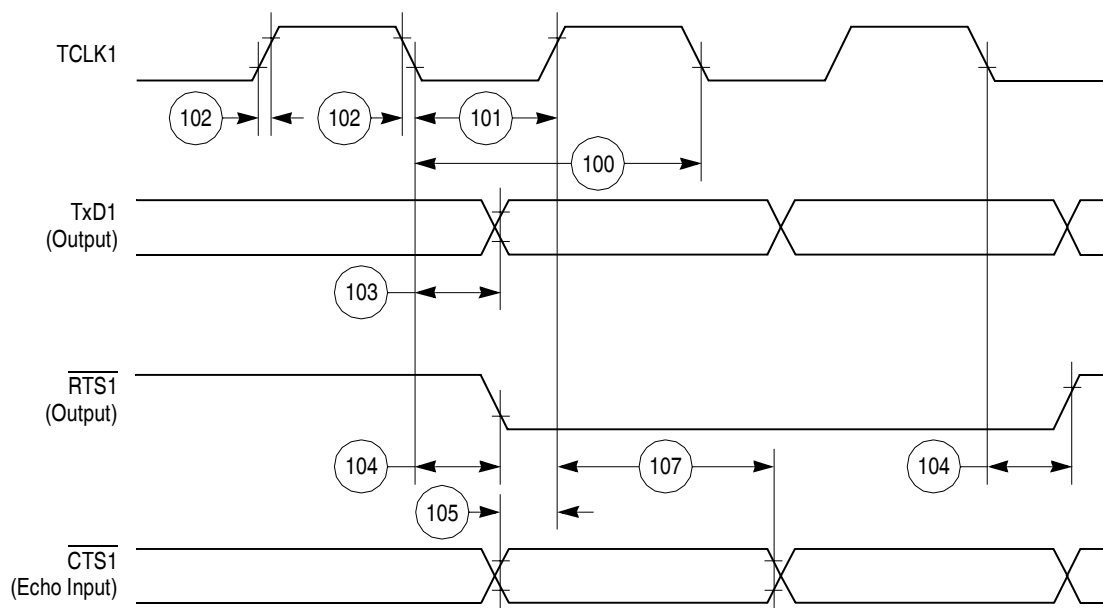


Figure 59. HDLC Bus Timing Diagram

11.8 Ethernet Electrical Specifications

Table 22 provides the Ethernet timings as shown in Figure 60 through Figure 64.

Table 22. Ethernet Timing

Num	Characteristic	All Frequencies		Unit
		Min	Max	
120	CLSN width high	40	—	ns
121	RCLK1 rise/fall time	—	15	ns
122	RCLK1 width low	40	—	ns
123	RCLK1 clock period ¹	80	120	ns
124	RXD1 setup time	20	—	ns
125	RXD1 hold time	5	—	ns
126	RENA active delay (from RCLK1 rising edge of the last data bit)	10	—	ns
127	RENA width low	100	—	ns
128	TCLK1 rise/fall time	—	15	ns
129	TCLK1 width low	40	—	ns
130	TCLK1 clock period ¹	99	101	ns
131	TXD1 active delay (from TCLK1 rising edge)	10	50	ns
132	TXD1 inactive delay (from TCLK1 rising edge)	10	50	ns
133	TENA active delay (from TCLK1 rising edge)	10	50	ns

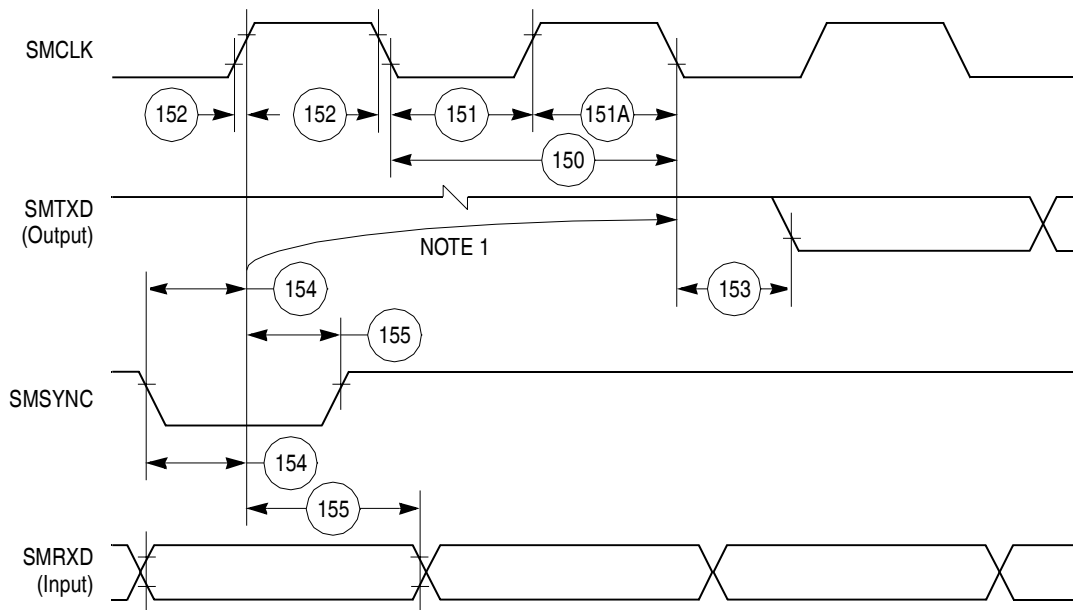
11.9 SMC Transparent AC Electrical Specifications

Table 23 provides the SMC transparent timings as shown in Figure 65.

Table 23. SMC Transparent Timing

Num	Characteristic	All Frequencies		Unit
		Min	Max	
150	SMCLK clock period ¹	100	—	ns
151	SMCLK width low	50	—	ns
151A	SMCLK width high	50	—	ns
152	SMCLK rise/fall time	—	15	ns
153	SMTXD active delay (from SMCLK falling edge)	10	50	ns
154	SMRXD/SMSYNC setup time	20	—	ns
155	RXD1/SMSYNC hold time	5	—	ns

¹ SyncCLK must be at least twice as fast as SMCLK.



NOTE:

1. This delay is equal to an integer number of character-length clocks.

Figure 65. SMC Transparent Timing Diagram

11.10 SPI Master AC Electrical Specifications

Table 24 provides the SPI master timings as shown in Figure 66 though Figure 67.

Table 24. SPI Master Timing

Num	Characteristic	All Frequencies		Unit
		Min	Max	
160	MASTER cycle time	4	1024	t_{cyc}
161	MASTER clock (SCK) high or low time	2	512	t_{cyc}
162	MASTER data setup time (inputs)	15	—	ns
163	Master data hold time (inputs)	0	—	ns
164	Master data valid (after SCK edge)	—	10	ns
165	Master data hold time (outputs)	0	—	ns
166	Rise time output	—	15	ns
167	Fall time output	—	15	ns

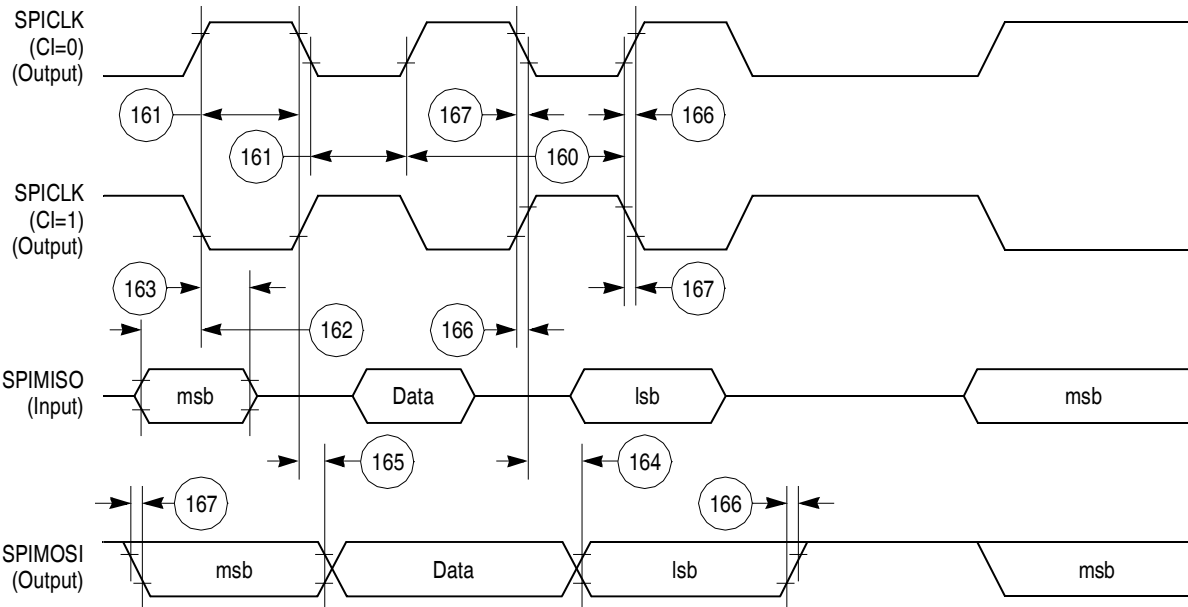


Figure 66. SPI Master (CP = 0) Timing Diagram

Table 33. MPC862/857T/857DSL Derivatives (continued)

Device	Number of SCCs ¹	Ethernet Support	Multi-Channel HDLC Support	ATM Support	Cache Size	
					Instruction	Data
MPC857T	One (SCC1)	10/100 Mbps	Yes	Yes	4 Kbytes	4 Kbytes
MPC857DSL	One (SCC1)	10/100 Mbps	No	Up to 4 addresses	4 Kbytes	4 Kbytes

¹ Serial communications controller (SCC)

Table 34 identifies the packages and operating frequencies orderable for the MPC862/857T/857DSL derivative devices.

Table 34. MPC862/857T/857DSL Package/Frequency Orderable

Package Type	Temperature (Tj)	Frequency (MHz)	Order Number
Plastic ball grid array (ZP suffix)	0°C to 105°C	50	XPC862PZP50B XPC862TZP50B XPC857TZP50B XPC857DSLZP50B
		66	XPC862PZP66B XPC862TZP66B XPC857TZP66B XPC857DSLZP66B
		80	XPC862PZP80B XPC862TZP80B XPC857TZP80B
		100	XPC862PZP100B XPC862TZP100B XPC857TZP100B
Plastic ball grid array (CZP suffix)	-40°C to 115°C	66 ¹	XPC862PCZP66B XPC857TCZP66B

¹ Additional extended temperature devices can be made available at 50MHz, 66MHz, and 80MHz

14.1 Pin Assignments

Figure 77 shows the top view pinout of the PBGA package. For additional information, see the *MPC862 PowerQUICC Family User's Manual*.

NOTE: This is the top view of the device.

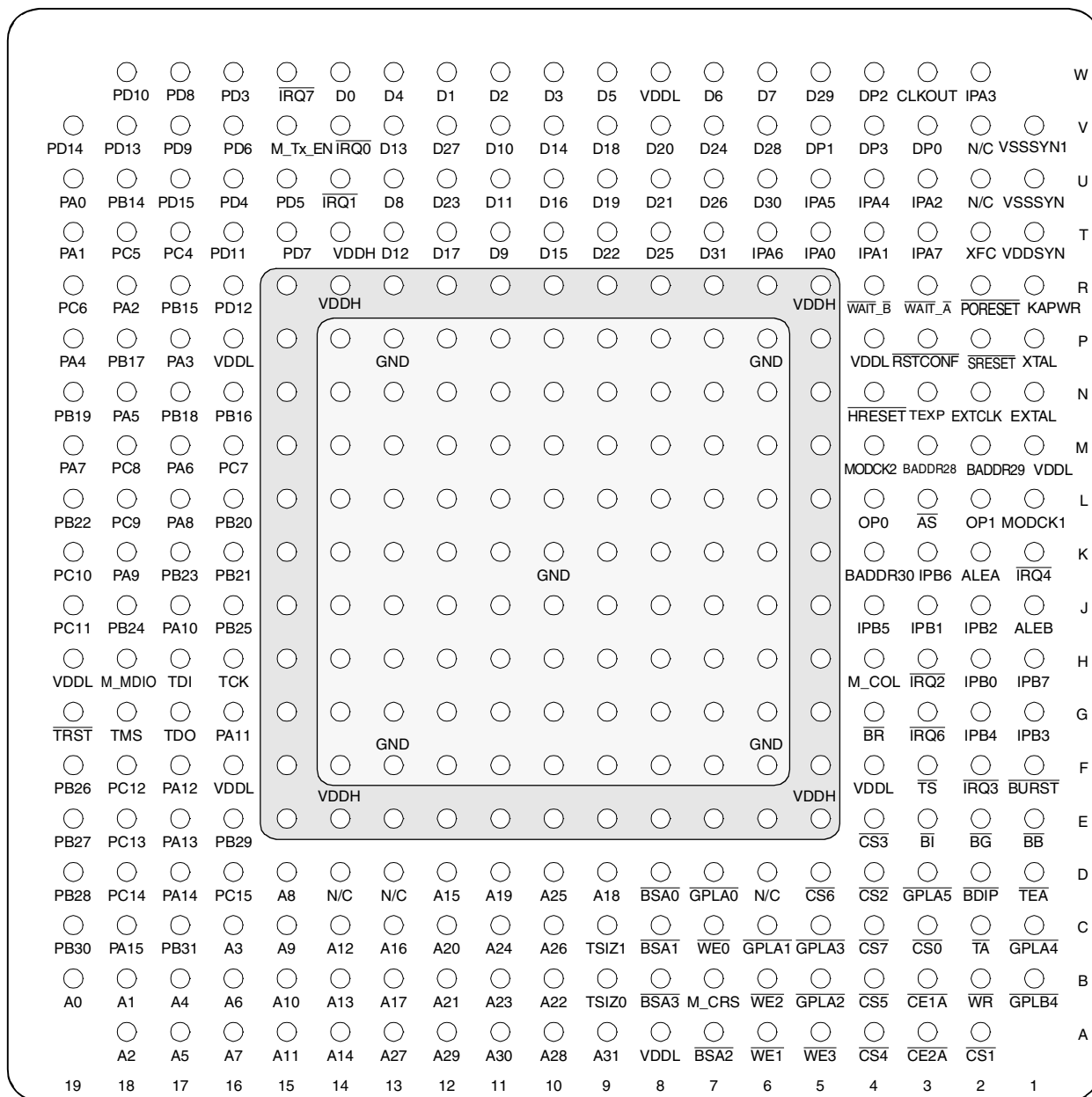


Figure 77. Pinout of the PBGA Package

Table 35. Pin Assignments (continued)

Name	Pin Number	Type
PA2 CLK6 <u>TOUT3</u> L1RCLKB	R18	Bidirectional
PA1 CLK7 BRGO4 TIN4	T19	Bidirectional
PA0 CLK8 <u>TOUT4</u> L1TCLKB	U19	Bidirectional
PB31 <u>SPISEL</u> <u>REJECT1</u>	C17	Bidirectional (Optional: Open-drain)
PB30 SPICLK <u>RSTR2</u>	C19	Bidirectional (Optional: Open-drain)
PB29 SPIMOSI	E16	Bidirectional (Optional: Open-drain)
PB28 SPIMISO BRGO4	D19	Bidirectional (Optional: Open-drain)
PB27 I2CSDA BRGO1	E19	Bidirectional (Optional: Open-drain)
PB26 I2CSCL BRGO2	F19	Bidirectional (Optional: Open-drain)
PB25 RXADDR3 ² SMTXD1	J16	Bidirectional (Optional: Open-drain)
PB24 TXADDR3 ² SMRXD1	J18	Bidirectional (Optional: Open-drain)
PB23 TXADDR2 ² <u>SDACK1</u> <u>SMSYN1</u>	K17	Bidirectional (Optional: Open-drain)
PB22 TXADDR4 ² <u>SDACK2</u> <u>SMSYN2</u>	L19	Bidirectional (Optional: Open-drain)

Table 35. Pin Assignments (continued)

Name	Pin Number	Type
PB21 SMTXD2 L1CLKOB PHSEL1 ¹ TXADDR1 ²	K16	Bidirectional (Optional: Open-drain)
PB20 SMRXD2 L1CLKOA PHSEL0 ¹ TXADDR0 ²	L16	Bidirectional (Optional: Open-drain)
PB19 <u>RTS1</u> L1ST1	N19	Bidirectional (Optional: Open-drain)
PB18 RXADDR4 ² <u>RTS2</u> L1ST2	N17	Bidirectional (Optional: Open-drain)
PB17 <u>L1RQb</u> L1ST3 <u>RTS3</u> PHREQ1 ¹ RXADDR1 ²	P18	Bidirectional (Optional: Open-drain)
PB16 <u>L1RQa</u> L1ST4 <u>RTS4</u> PHREQ0 ¹ RXADDR0 ²	N16	Bidirectional (Optional: Open-drain)
PB15 BRGO3 TxClav	R17	Bidirectional
PB14 RXADDR2 ² <u>RSTRT1</u>	U18	Bidirectional
PC15 <u>DREQ0</u> <u>RTS1</u> L1ST1 RxClav	D16	Bidirectional
PC14 <u>DREQ1</u> <u>RTS2</u> L1ST2	D18	Bidirectional

Table 35. Pin Assignments (continued)

Name	Pin Number	Type
TRST	G19	Input
TDO DSDO	G17	Output
M_CRS	B7	Input
M_MDIO	H18	Bidirectional
M_TXEN	V15	Output
M_COL	H4	Input
KAPWR	R1	Power
GND	F6, F7, F8, F9, F10, F11, F12, F13, F14, G6, G7, G8, G9, G10, G11, G12, G13, G14, H6, H7, H8, H9, H10, H11, H12, H13, H14, J6, J7, J8, J9, J10, J11, J12, J13, J14, K6, K7, K8, K9, K10, K11, K12, K13, K14, L6, L7, L8, L9, L10, L11, L12, L13, L14, M6, M7, M8, M9, M10, M11, M12, M13, M14, N6, N7, N8, N9, N10, N11, N12, N13, N14, P6, P7, P8, P9, P10, P11, P12, P13, P14	Power
VDDL	A8, M1, W8, H19, F4, F16, P4, P16	Power
VDDH	E5, E6, E7, E8, E9, E10, E11, E12, E13, E14, E15, F5, F15, G5, G15, H5, H15, J5, J15, K5, K15, L5, L15, M5, M15, N5, N15, P5, P15, R5, R6, R7, R8, R9, R10, R11, R12, R13, R14, R15, T14	Power
N/C	D6, D13, D14, U2, V2	No-connect

¹ Classic SAR mode only

² ESAR mode only

14.2 Mechanical Dimensions of the PBGA Package

For more information on the printed circuit board layout of the PBGA package, including thermal via design and suggested pad layout, please refer to *Plastic Ball Grid Array Application Note* (order number: AN1231/D) available from your local Freescale sales office. [Figure 78](#) shows the mechanical dimensions of the PBGA package.